

107577173

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Wolfgang Hetzel et al.

Filed: Herewith

Docket: I431.153.101/FIN546PCT/US

Title: SEMICONDUCTOR DEVICE WITH PLASTIC PACKAGE MOLDING
COMPOUND, SEMICONDUCTOR CHIP AND LEADFRAME AND
METHOD FOR PRODUCING SAME.

107577173 26 APR 2006

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

In compliance with the duty of disclosure under 37 C.F.R. § 1.56, it is respectfully requested that this Information Disclosure Statement be entered and the documents listed on attached form 1449 be considered by the Examiner and made of record. Any required copies of patents, publications or other documents are enclosed for the Examiner's review. Pursuant to the provisions of M.P.E.P. 609, Applicant further requests a copy of the 1449 form, marked as being considered and initialed by the Examiner, be returned with the next Official Communication.

Since this Information Disclosure Statement is being submitted within three months of filing national application; or date of entry of national application; or before the mailing date of the first Office Action on the merits, a fee has not been enclosed. However, if such fee is required, the Patent Office is hereby authorized to charge Deposit Account No. 500471 for fees as set forth under 37 C.F.R. 1.17(p).

Information Disclosure Statement

Applicant: Wolfgang Hetzel et al.

Filing Date: Herewith

Docket: I431.156.101

Title: SEMICONDUCTOR DEVICE WITH PLASTIC PACKAGE MOLDING COMPOUND,
SEMICONDUCTOR CHIP AND LEADFRAME AND METHOD FOR PRODUCING SAME

10/577173

APPROPRIATE TO 26 APR 2006

Applicant respectfully requests consideration of these references during prosecution of the above-identified matter. The Examiner is invited to contact the Applicant's representative at the below-listed telephone number if there are any questions regarding this Communication or the tendered references.

Respectfully submitted,

Wolfgang Hetzel et al.,

By their attorneys,

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Dated: April 26, 2006
SED:dmw

Steven E. Dicke
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CERTIFICATE UNDER 37 C.F.R. 1.10:

"Express Mail" mailing label number: EV309842094US

Date of Deposit: April 26, 2006

The undersigned hereby certifies that this paper or papers, as described herein, are being deposited in the United States Postal Service "Express Mail Post Office to Addressee" service under 37 C.F.R. 1.10 on the date indicated above and is addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

By Vanessa Carels
Name: Vanessa Carels

FORM PTO-1449	Docket No.: 431.153.101	Serial No.: Unknown 100588173
LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT(S) INFORMATION DISCLOSURE STATEMENT	Applicant: Wolfgang Hetzel et al.	
	Filing Date: April 26, 2006	Group Art Unit:

U.S. PATENT DOCUMENTS

Examiner Initial	Document No.	Date	Name	Class	Sub Class	Filing Date if Appropriate
AA	5,874,784	02/23/1999	Aoki et al.			
AB	6,429,372	08/06/2002	Taguchi et al.			
AC	2001/0022404A1	09/20/2001	Yamamoto et al.			
AD	2002/0045294A1	04/18/2002	Barrett et al.			
AE	2002/0056561A1	05/16/2002	Yaguchi et al.			
AF	2002/0137257A1	09/26/2002	Huang et al.			
AG	2003/0111738A1	06/19/2003	Buschbom			
AH	2004/0032014A1	02/19/2004	Lai et al.			
AI						
AJ						
AK						
AL						

FOREIGN PATENT DOCUMENTS

	Document No.	Date	Country	Class	Sub Class	Translated Yes No (Abstract Only)
AM	2003-258158	12-09-2003	Japan			<input checked="" type="checkbox"/> <input type="checkbox"/>
AN						<input type="checkbox"/> <input type="checkbox"/>
AO						<input type="checkbox"/> <input type="checkbox"/>
AP						<input type="checkbox"/> <input type="checkbox"/>

OTHER ART (Including Author, Title, Date, Pertinent Pages, etc.)

AQ	
AR	

EXAMINER: DATE CONSIDERED:

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.